



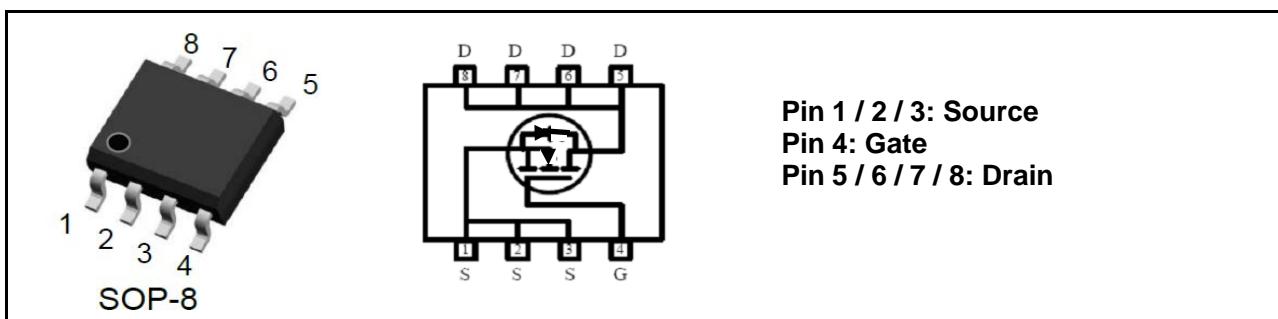
N-Channel Enhancement-Mode MOSFET (30V, 10A)

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(on)}$ (mΩ) Typ.
30V	10A	9 @ $V_{GS} = 10V$, $I_D = 6.9A$
		13 @ $V_{GS} = 4.5V$, $I_D = 5.8A$

Features

- Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and maximum DC current capability
- Lead (Pb) -free and halogen-free



Absolute Maximum Ratings ($T_A=25^\circ C$, unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current (Continuous)@ $T_A=25^\circ C$	10	A
	Drain Current (Continuous)@ $T_A=75^\circ C$	8	A
I_{DM}	Drain Current (Pulsed) ^a	50	A
P_D	Total Power Dissipation @ $T_A=25^\circ C$	2.5	W
	Total Power Dissipation @ $T_A=75^\circ C$	1.3	W
I_S	Maximum Diode Forward Current	1.7	A
T_j, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +150	°C
R_{QJA}	Thermal Resistance Junction to Ambient (PCB mounted) ^b	50	°C/W

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.

b: 1-in² 2oz Cu PCB board



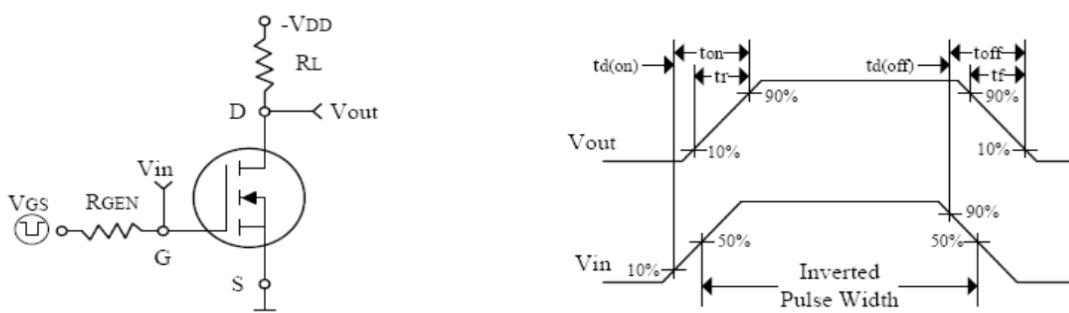
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Electrical Characteristics ($T_A=25^\circ\text{C}$, unless otherwise noted)

Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
• Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30	33	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
• On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0	1.7	2.2	V
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=10\text{A}$	-	9	12	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=5.8\text{A}$	-	13	15	
• Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	710	-	PF
C_{oss}	Output Capacitance		-	155	-	
C_{rss}	Reverse Transfer Capacitance		-	145	-	
• Switching Characteristics						
Q_g	Total Gate Charge	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=9\text{A}, V_{\text{GS}}=4.5\text{V}$	-	8	-	nC
Q_{gs}	Gate-Source Charge		-	3.3	-	
Q_{gd}	Gate-Drain Charge		-	2.7	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}, R_L=15\Omega, I_{\text{D}}=1\text{A}, V_{\text{GEN}}=10\text{V}, RG=6\Omega$	-	7	-	nS
t_r	Turn-on Rise Time		-	7	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	22	-	
t_f	Turn-off Fall Time		-	7	-	
• Drain-Source Diode Characteristics						
V_{SD}	Drain-Source Diode Forward	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=2.0\text{A}$	-	-	1.2	V

Note: Pulse Test: Pulse Width $\leq 300\text{us}$, Duty Cycle $\leq 2\%$



Switching Test Circuit and Switching Waveforms



Typical Characteristics Curves ($T_a=25^\circ\text{C}$, unless otherwise note)

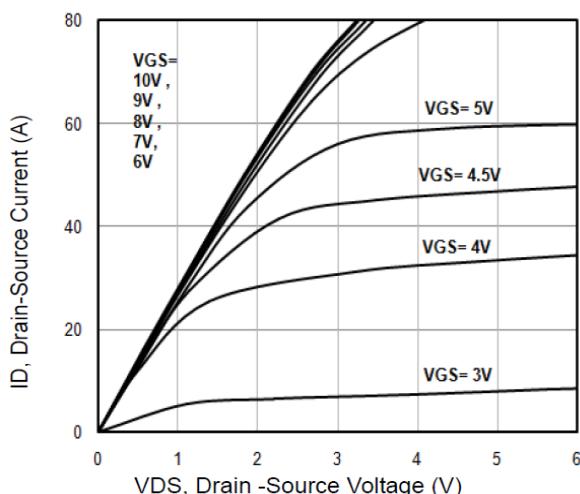


Fig1. Typical Output Characteristics

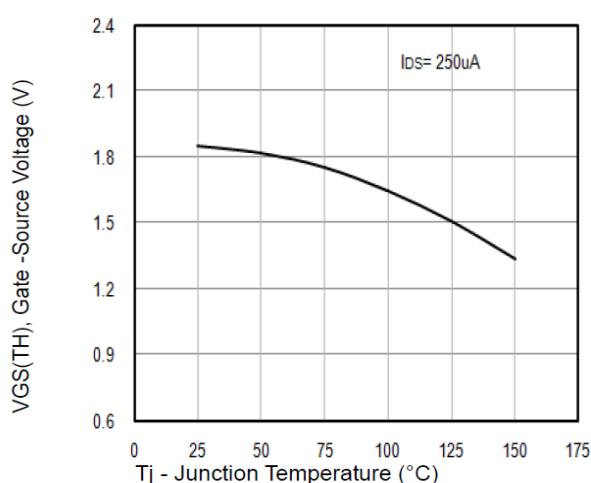


Fig2. $V_{GS(TH)}$ Gate -Source Voltage Vs. T_j

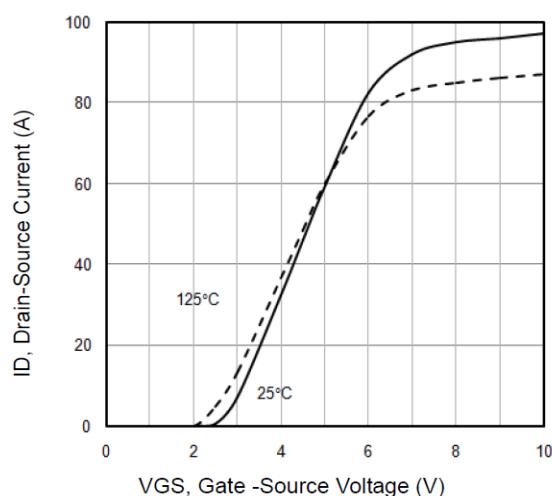


Fig3. Typical Transfer Characteristics

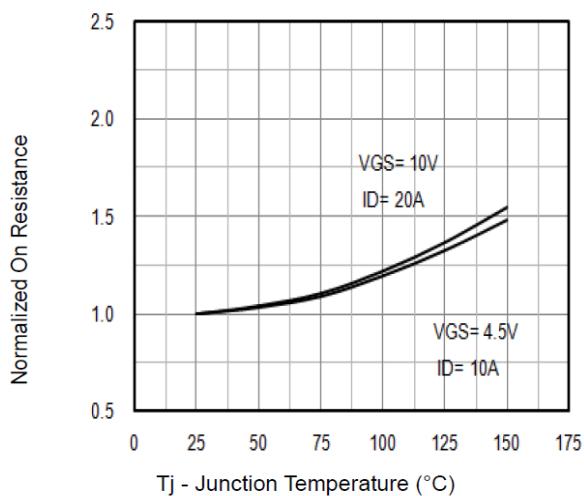


Fig4. Normalized On-Resistance Vs. T_j

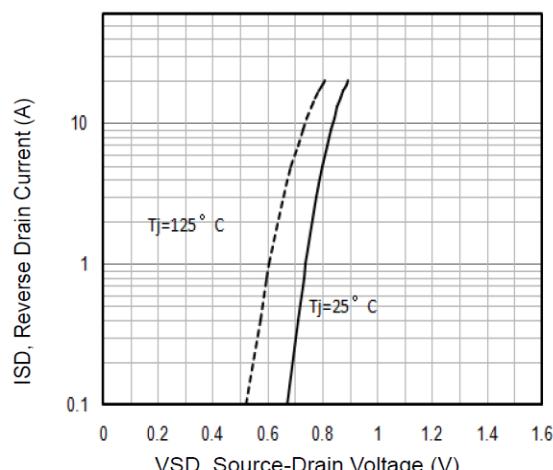


Fig5. Typical Source-Drain Diode Forward Voltage

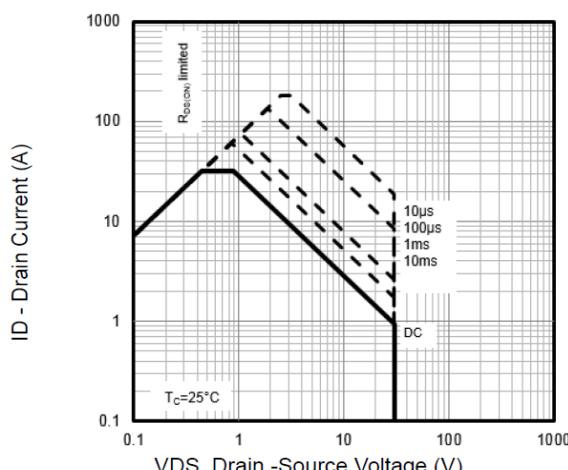


Fig6. Maximum Safe Operating Area

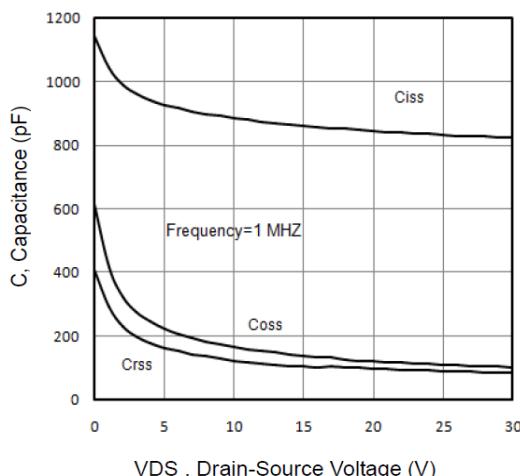


Fig7. Typical Capacitance Vs.Drain-Source Voltage

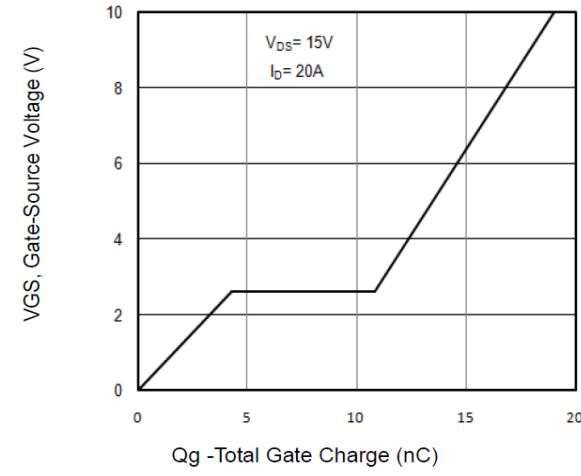


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

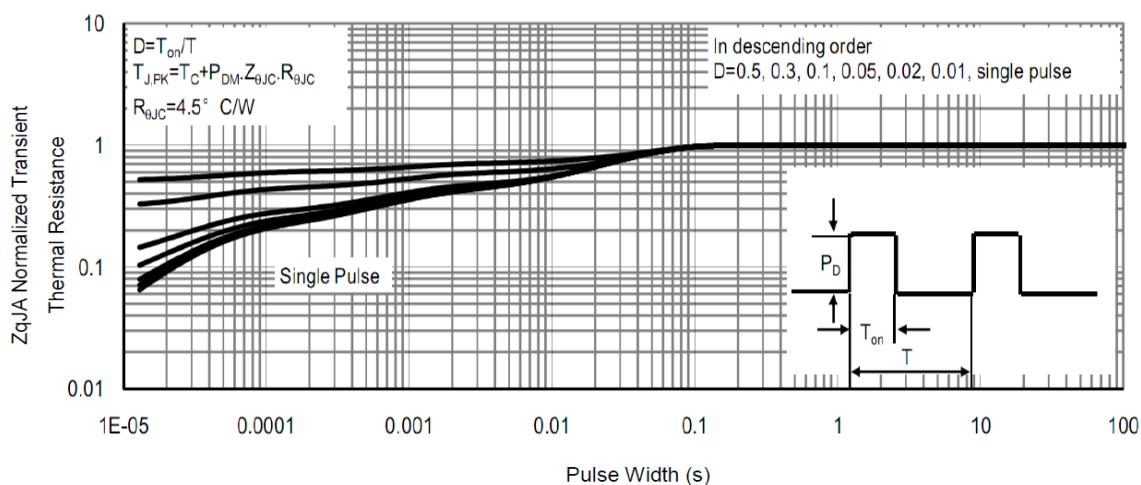


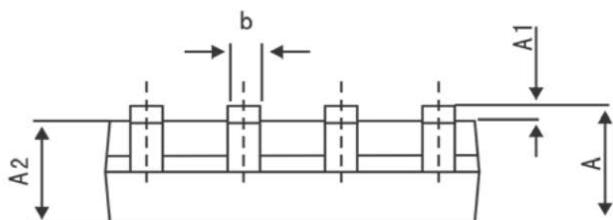
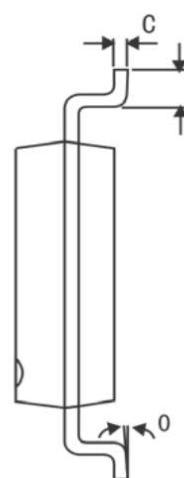
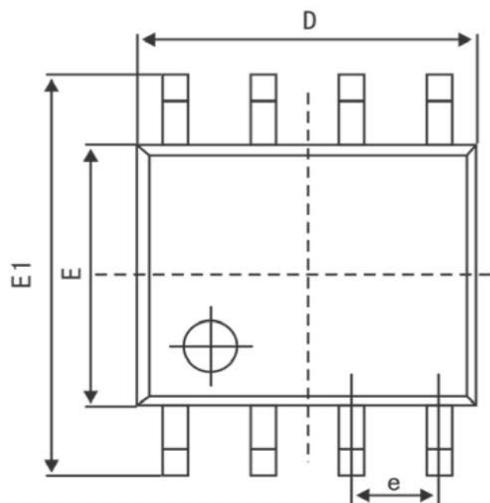
Fig9. Normalized Maximum Transient Thermal Impedance



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ET4410 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters (MM)		Dimensions In Inches (MIL)	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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